



DMT4014LDV

PowerDI3333-8

#### **Product Summary**

| BV <sub>DSS</sub> | Rds(on) Max                   | l⊳ Max<br>Tc = +25°C |
|-------------------|-------------------------------|----------------------|
|                   | 19mΩ @ V <sub>GS</sub> = 10V  | 26.5A                |
| 40V               | 29mΩ @ V <sub>GS</sub> = 4.5V | 21.8A                |

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$  yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Wireless Charging
- DC-DC Converters
- Power Management

## Features and Benefits

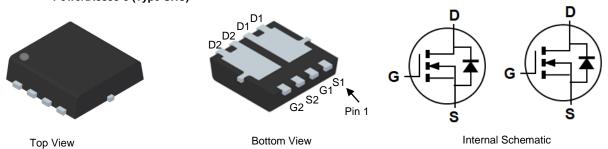
 100% Unclamped Inductive Switching (UIS) Test in Production — Ensures More Reliable and Robust End Application

40V N-CHANNEL ENHANCEMENT MODE MOSFET

- Low R<sub>DS(ON)</sub> Ensures On-State Losses Are Minimized
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)



## Ordering Information (Note 4)

| Part Number   | Case                     | Packaging         |
|---------------|--------------------------|-------------------|
| DMT4014LDV-7  | PowerDI3333-8 (Type UXC) | 2,000/Tape & Reel |
| DMT4014LDV-13 | PowerDI3333-8 (Type UXC) | 3,000/Tape & Reel |

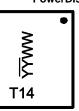
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



PowerDI3333-8 (Type UXC)

 $\frac{T14}{YY} = Product Type Marking Code$   $\frac{YY}{YY} = Date Code Marking$   $\frac{YY}{Y} = Last Two Digits of Year (ex: 20 = 2020)$ WW = Week Code (01 to 53)

### PowerDI3333-8 (Type UXC)



# Maximum Ratings (@TA = +25°C, unless otherwise specified.)

| Characteristic   | Symbol       | Value  | Unit            |              |    |
|--|--------------|--|-----------------|--------------|----|
| Drain-Source Voltage   |              | V <sub>DSS</sub>                                 | 40              | V            |    |
| Gate-Source Voltage  |              | Vgss   | ±20             | V            |    |
| Continuous Drain Current (Note 6) $V_{GS} = 10V$<br>$T_C = +25^{\circ}C$<br>$T_C = +70^{\circ}C$ |              |  | ID              | 26.5<br>21.2 | А  |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V  | Steady State | T <sub>A</sub> = +25°C<br>T <sub>A</sub> = +70°C | lo              | 8.5<br>6.8   | А  |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)   |              | Ідм  | 100             | A            |    |
| Maximum Continuous Body Diode Forward Current (N   |              | ls   | 2.7             | A            |    |
| Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)                                  |              |  | lsм             | 100          | А  |
| Avalanche Current, L = 0.1mH   |              |  | las             | 19.8         | A  |
| Avalanche Energy, L = 0.1mH  |              |  | E <sub>AS</sub> | 19.6         | mJ |

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                   |                        | Symbol           | Value       | Unit |
|--|------------------------|------------------|-------------|------|
| Total Power Dissipation (Note 5)                 | T <sub>A</sub> = +25°C | PD               | 1.0         | W    |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State           | RθJA             | 124         | °C/W |
| Total Power Dissipation (Note 6)                 | T <sub>A</sub> = +25°C | PD               | 2.1         | W    |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State           | R <sub>0JA</sub> | 61          | °C/W |
| Thermal Resistance, Junction to Case (Note 6)    | Rejc                   | 6.2              | °C/W        |      |
| Operating and Storage Temperature Range          |                        | TJ, TSTG         | -55 to +150 | °C   |

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

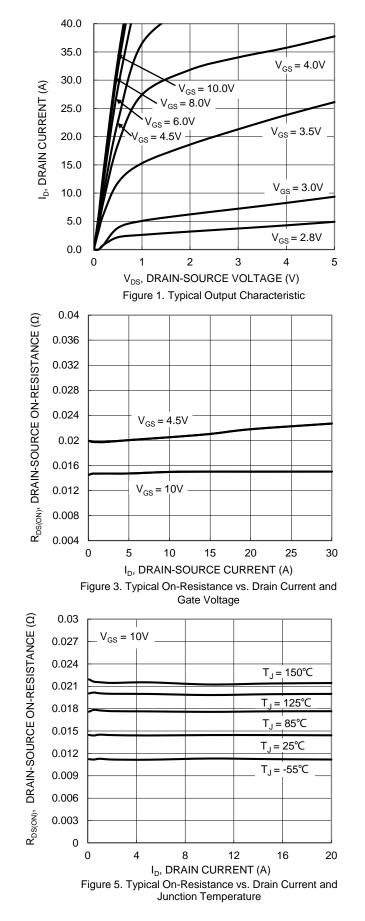
| <u>Ob eventerintic</u>                     | Cumphiel        | Min | True | May  | 11    | Test Condition  |  |
|--|-----------------|-----|------|------|-------|---|--|
|  | Symbol          | Min | Тур  | Max  | Unit  | Test Condition  |  |
| OFF CHARACTERISTICS (Note 7)               |                 | 40  | r    |      |       |   |  |
| Drain-Source Breakdown Voltage             | BVDSS           | 40  |      |      | V     | $V_{GS} = 0V, I_D = 1mA$                                      |  |
| Zero Gate Voltage Drain Current            | IDSS            | _   | -    | 1    | μA    | V <sub>DS</sub> = 32V, V <sub>GS</sub> = 0V                   |  |
| Gate-Source Leakage                        | lgss            | —   | —    | ±100 | nA    | $V_{GS} = \pm 20V, V_{DS} = 0V$                               |  |
| ON CHARACTERISTICS (Note 7)                |                 |     |      |      | -     | 1   |  |
| Gate Threshold Voltage                     | VGS(TH)         | 1   | —    | 3    | V     | $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$                         |  |
| Static Drain-Source On-Resistance          | Bacati          |     | 14.7 | 19   | mΩ    | $V_{GS} = 10V, I_D = 20A$                                     |  |
| Static Drain-Source On-Resistance          | Rds(on)         |     | 21.2 | 29   | 11152 | VGS = 4.5V, ID = 15A  |  |
| Diode Forward Voltage                      | Vsd             |     | 1.0  | 1.2  | V     | $V_{GS} = 0V, I_{S} = 20A$                                    |  |
| DYNAMIC CHARACTERISTICS (Note 8)           |                 |     |      |      |       |   |  |
| Input Capacitance                          | Ciss            |     | 750  |      | pF    |   |  |
| Output Capacitance                         | Coss            |     | 225  | —    | pF    | − V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V,<br>− f = 1MHz  |  |
| Reverse Transfer Capacitance               | Crss            | _   | 21   | _    | pF    |   |  |
| Gate Resistance                            | Rg              | _   | 1.1  | _    | Ω     | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$                          |  |
| Total Gate Charge (V <sub>GS</sub> = 4.5V) | Qg              |     | 5.7  | _    | nC    |   |  |
| Total Gate Charge (V <sub>GS</sub> = 10V)  | Qg              |     | 11.2 | —    | nC    |   |  |
| Gate-Source Charge                         | Q <sub>gs</sub> |     | 2.0  | —    | nC    | $V_{DS} = 20V, I_{D} = 20A$                                   |  |
| Gate-Drain Charge                          | Q <sub>gd</sub> |     | 2.2  | —    | nC    |   |  |
| Turn-On Delay Time                         | tD(ON)          | _   | 3.5  | _    | ns    |   |  |
| Turn-On Rise Time                          | t <sub>R</sub>  | _   | 4.6  | _    | ns    | $V_{GS} = 10V, V_{DD} = 20V,$<br>$R_g = 1.6\Omega, I_D = 20A$ |  |
| Turn-Off Delay Time                        | tD(OFF)         | _   | 12.4 | _    | ns    |   |  |
| Turn-Off Fall Time                         | tF              |     | 4.9  |      | ns    |   |  |
| Body Diode Reverse Recovery Time           | trr             |     | 11.3 | —    | ns    |   |  |
| Body Diode Reverse Recovery Charge         | Q <sub>RR</sub> | _   | 9.5  |      | nC    | l⊧ = 15A, di/dt = 400A/µs                                     |  |

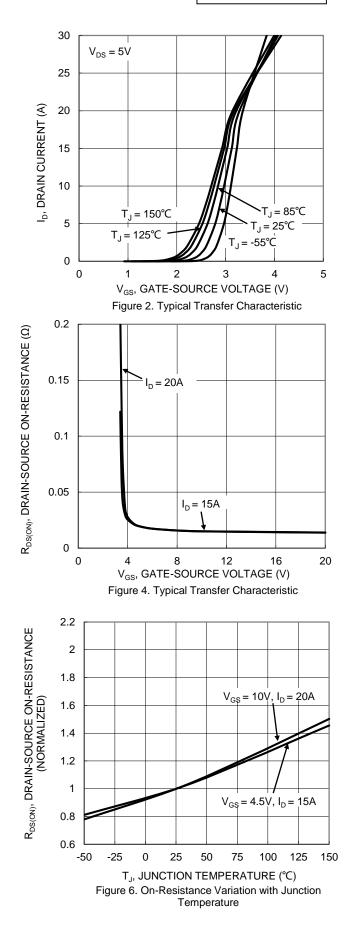
Notes:

Device mounted on FR-4 PCB, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.



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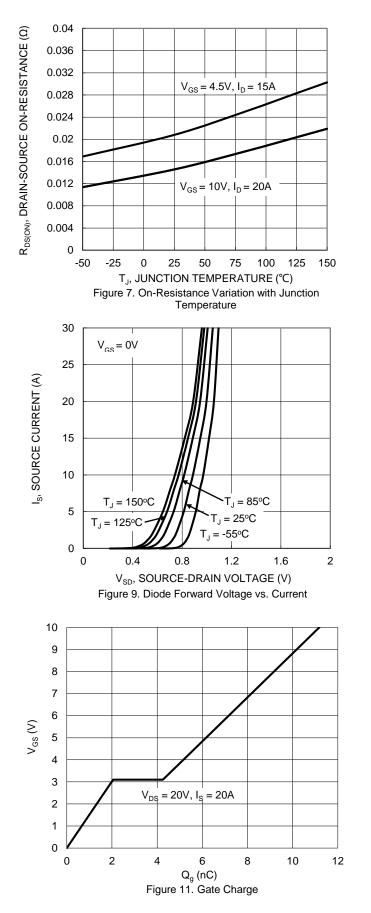


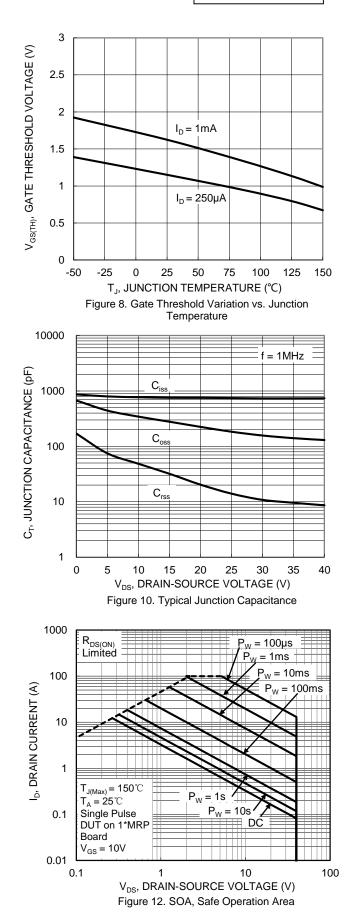


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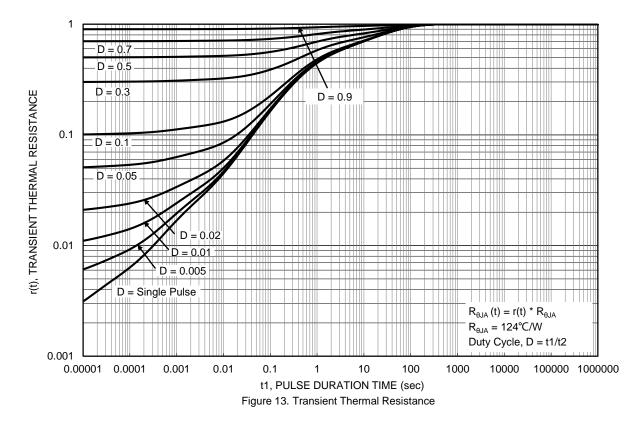


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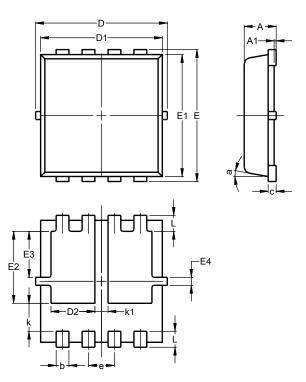






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

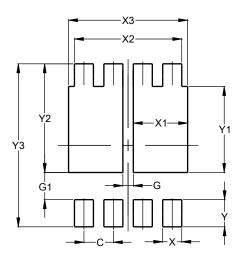


| PowerDI3333-8<br>(Type UXC) |      |      |      |  |  |
|-----------------------------|------|------|------|--|--|
| Dim                         | Min  | Max  | Тур  |  |  |
| Α                           | 0.75 | 0.85 | 0.80 |  |  |
| A1                          | 0.00 | 0.05 |      |  |  |
| b                           | 0.25 | 0.40 | 0.32 |  |  |
| С                           | 0.10 | 0.25 | 0.15 |  |  |
| D                           | 3.20 | 3.40 | 3.30 |  |  |
| D1                          | 2.95 | 3.15 | 3.05 |  |  |
| D2                          | 0.90 | 1.30 | 1.10 |  |  |
| Е                           | 3.20 | 3.40 | 3.30 |  |  |
| E1                          | 2.95 | 3.15 | 3.05 |  |  |
| E2                          | 1.60 | 2.00 | 1.80 |  |  |
| E3                          | 0.95 | 1.35 | 1.15 |  |  |
| E4                          | 0.10 | 0.30 | 0.20 |  |  |
| е                           | -    | -    | 0.65 |  |  |
| L                           | 0.30 | 0.50 | 0.40 |  |  |
| k                           | 0.50 | 0.90 | 0.70 |  |  |
| k1                          | 0.13 | 0.53 | 0.33 |  |  |
| а                           | 0°   | 12°  | 10°  |  |  |
| All Dimensions in mm        |      |      |      |  |  |

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8 (Type UXC)



| Dimensions | Value (in mm) |  |  |  |
|------------|---------------|--|--|--|
| С          | 0.650         |  |  |  |
| G          | 0.230         |  |  |  |
| G1         | 0.600         |  |  |  |
| Х          | 0.420         |  |  |  |
| X1         | 1.200         |  |  |  |
| X2         | 2.370         |  |  |  |
| X3         | 2.630         |  |  |  |
| Y          | 0.600         |  |  |  |
| Y1         | 1.900         |  |  |  |
| Y2         | 2.400         |  |  |  |
| Y3         | 3.600         |  |  |  |

# PowerDI3333-8 (Type UXC)



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